

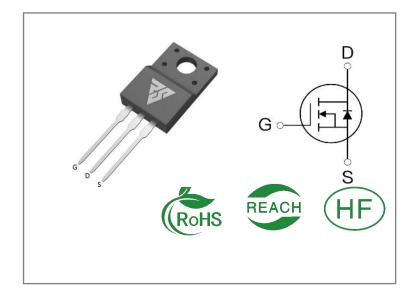
ID	R _{DS} (ON)(Typ)	VDSS
30A	115mΩ	600V

Applications:

- Switch Mode Power Supply(SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)
- AC-DC Switching Power Supply

Features:

- Fast switching speed
- 100% avalanche tested
- Improved dv/dt capability



Ordering Information

Part Number	Package	Marking	Packing	Qty.
RS60R130F	T0-220F	RS60R130F	Tube	50 PCS

Absolute Maximun Ratings Tc= 25 ℃ unless otherwise specified

Symbol	Parameter	RS60R130F	Units
VDSS	Drain-to-Source Voltage	650	V
ID	Continuous Drain Current TC=25℃	30	
ID	Continuous Drain Current TC=100℃	19.5	A
IDM	Pulsed Drain Current (Note*1)	90	
PD	Power Dissipation	34	W
VGS	Gate- to- Source Voltage	±30	V
	Single Pulse Avalanche Engergy		
EAS	L=10mH,VDD = 600V, RG = 25 Ω , TC=25 $^{\circ}$ C	330	mJ
dv/dt	MOSFET dv/ dt ruggedness VDS = 0400V	50	V/ns
dv/dt	Reverse diode dv/dt VDS = 0400V, Tj = 25° C,	15	V/ns
	ISD≤ID		
	Maximum Temperature for Soldering	300	
TL TPKG	Leads at 0.063in(1.6mm)from Case for 10 seconds	260	
	Package Body for 10 seconds	200	$^{\circ}$ C
TJ and	Operating Junction and Storage	EE +0.1EO	
TSTG	Temperature Range	-55 to 150	

^{*} Drain Current Limited by Maximum Junction Temperature

Caution: Stresses greater than those listed in the" Absolute Maximum Ratings" Table may cause permanent damage to the device.



Thermal Resistance

Symbol	Parameter	RS60R130F	Units	Test Conditions
RθJC	Junction-to-Case	3.7		Drain lead soldered to water cooled heatsink, PD adjusted for a peak
			°C/W	junction temperature of + 1 5 0 $^{\circ}\mathrm{C}$
RθJA	Junction-to- Ambient	80		1 cubic foot chamber,free air.

OFF Characteristics TJ= 25[°]C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BVDSS	Drain- to- source Breakdown Voltage	600			V	VGS=0V,ID=250μA
IDSS	Drain- to- Source Leakage Current			1	μΑ	VDS=600V,VGS=0 V
	Gate- to- Source Forward Leakage			100		VGS=30V ,VDS=0V
IGSS	Gate- to- Source Reverse Leakage			-100	nA	VGS=-30V ,VDS=0 V

ON Characteristics TJ=25 ℃ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
RDS(on)	Static Drain- to- Source On- Resistance(Note*2)		115	130	mΩ	VGS=10V,ID=15A
VGS(TH)	Gate Threshold Voltage	2		4	>	VGS=VDS,ID=250μ A

Resistive Switching Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
td(ON)	Turn- on Delay Time		30			
trise	Rise Time		45			VDS=300V
td(OFF)	Turn- OFF Delay Time		145		nS	ID=30A RG=25Ω
tfall	Fall Time		36			



Dynamic Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Ciss	Input Capacitance		1950	1		VGS=0V
Coss	Output Capacitance		245		pF	VDS=50V
Crss	Reverse Transfer Capacitance		29			f=1.0MHz
Qg	Total Gate Charge		50			VDS=480V
Qgs	Gate- to- Source Charge		10		nC	ID=30A
Qgd	Gate-to-Drain(" Miller") Charge		14			VGS=10V

Source-Drain Diode Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
IS	Continuous Source Current			30	Α	Integral pn- diode
ISM	Maximum Pulsed Current			90	Α	in MOSFET
VSD	Diode Forward Voltage			1.4	٧	IS=30A,VGS=0V
trr	Reverse Recovery Time		370		nS	VR=100V
Qrr	Reverse Recovery Charge		6.4		μС	IS=30A,di/dt=100A /μs

Notes:

^{* 1.} Repetitive rating, pulse width limited by maximum junction temperature.

^{* 2.} Pulse Test: Pulse width ≤ 300µs, Duty Cycle ≤ 2%



Typical Feature Curve

Figure 1. Output Characteristics

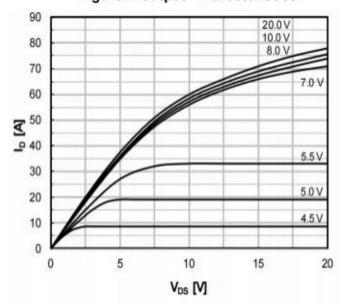


Figure 2. Transfer Characteristics

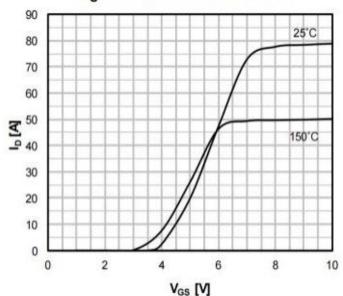


Figure 3. On-Resistance VS.Drain Current

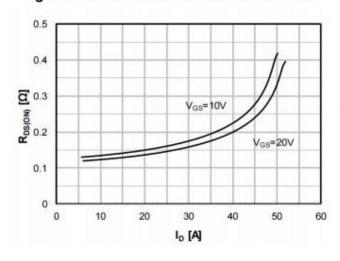


Figure 4. Capacitance

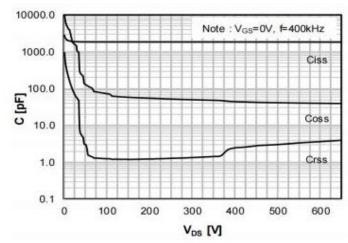


Figure 5. Gate Charge

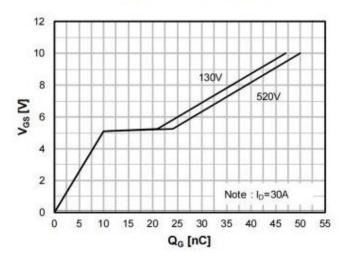
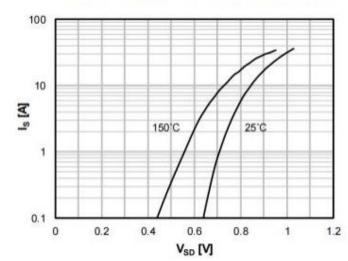


Figure 6. Body Diode Forward Voltage



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Figure 7.On-Resistan ce vs.
Junction Temperature

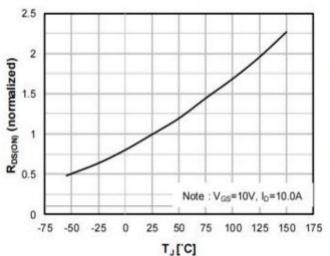


Figure 8.Bearkdown Voltage vs.

Junction Temperature

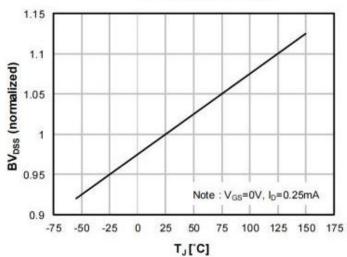
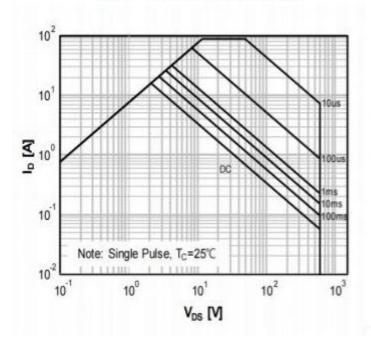
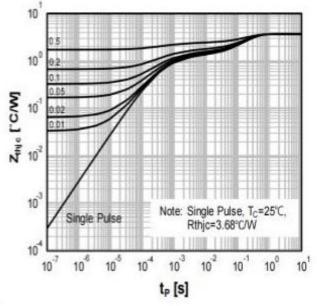


Figure 9. Safe operation area









Test Circuits and Waveforms

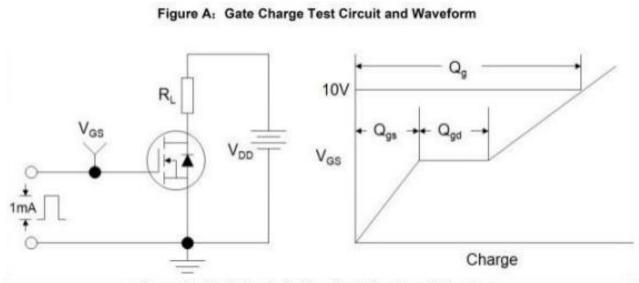


Figure B: Resistive Switching Test Circuit and Waveform

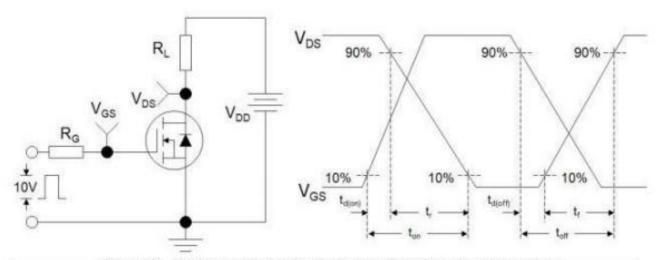
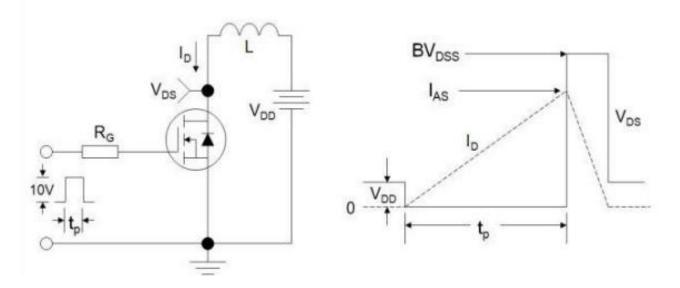
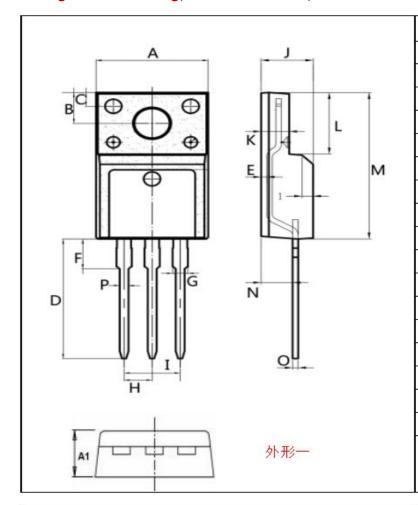


Figure C: Unclamped Inductive Switching Test Circuit and Waveform



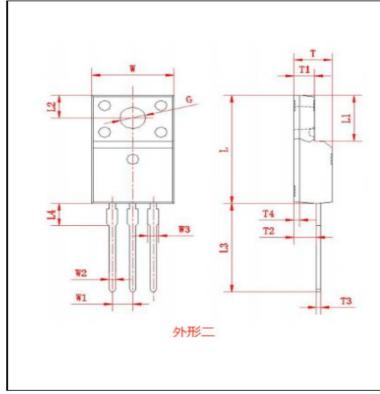


Package outline drawing(TO-220F Unit: mm)



Dim.	Min.	Max.
Α	9.95	10.36
A1	4.5	5.0
В	2.95	3.25
С	1.25	1.45
D	12.60	13.60
E	0.40	0.60
F	2.8	3.5
G	1.30	1.45
Н	(2.54	1)
1	(5.08	3)
J	4.60	4.75
K	2.45	2.65
L	6.5	6.8
М	15.4	16.0
N	2.25	3.05
0	0.45	0.55
Р	0.70	0.90

All Dimensions in millimeter



Dim.	Min.	Max.
W	9.95	10.36
W1	(2.5	4)
W2	0.70	0.90
W3	1.25	1.47
L	15.67	16.07
L1	6.48	6.88
L2	3.2	3.4
L3	12.6	13.6
L4	(3.23	3)
Т	4.50	4.90
T1	2.34	2.74
T2	2.25	2.95
Т3	0.45	0.60
T4	(0.	70)
G	3.08	3.28



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DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
IPB80P04P405ATMA2 2N7002W-G MCAC30N06Y-TP MCQ7328-TP NTMC083NP10M5L BXP7N65D BXP4N65F AOL1454G
WMJ80N60C4 BXP2N20L BXP2N65D BXT1150N10J BXT1700P06M TSM60NB380CP ROG RQ7L055BGTCR DMNH15H110SK3-13
SLF10N65ABV2 BSO203SP BSO211P IPA60R230P6